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**ELECTRONICS MANUFACTURING ASIA INNOVATION AWARDS/创新奖 2008**  
**OFFICIAL ENTRY FORM 报名表**

To qualify, please note the following:  
为免失去参评资格，请注意以下事项：

1. All manufacturing related products, materials and equipment submitted must be introduced and offered for sale between 1 March 2007 and 31 December 2007 in Asia. 参评产品、材料或设备必须为 2007 年 3 月 1 日至 2007 年 12 月 31 日间在亚洲公开发的。
2. All sections must be completed. Incomplete entries will be disqualified by the judges. 报名表内容必须填写完全，未完成报名表将被取消参评资格。
3. All entries must be accompanied with this form. **Product descriptions submitted must be in both English and Simplified Chinese.** 有参评产品必须附有此表。产品说明须包含中英文两种形式。
4. Entries must reach us by **31 January 2008**. Please see Section G for submission guidelines. 报名截至日期为 2008 年 1 月 31 日。具体提交方式请参阅报名表 G 部分。

**A. COMPANY INFORMATION 公司信息**

<b>Company Name:</b> 公司名称:	
<b>Contact:</b> 联系人:	
<b>Job Title:</b> 职位:	
<b>Mailing Address:</b> 通讯地址:	
<b>Postal Code:</b> 邮编:	
<b>City:</b> 城市:	
<b>Country:</b> 国家:	
<b>Tel:</b> 电话:	
<b>Fax:</b> 传真:	
<b>Mobile:</b> 手机:	
<b>Email Address</b> 邮箱:	

## B. AWARD CATEGORIES 奖项类别

(Tick as many as you would like; entry fee is USD500 per category.)  
 (请勾选您欲参评的奖项，报名费\$500 美元/每项)

✓	Categories	奖项类别
	Adhesive/Coating/Encapsulating Materials	胶粘 / 涂覆 / 灌封材料
	Assembly Line Systems/Equipment	组装生产线系统 / 设备
	Cleaning Equipment	清洗设备
	Cleaning Materials	清洗材料
	Contract Services	合约制造服务
	Dispensing Systems/Equipment	点涂系统 / 设备
	Environmentally Friendly Products/Materials	环保产品 / 材料
	Environmentally Friendly/Alternative Energy Production Equipment	环保 / 可再生能源生产设备
	Identification (ID) Systems	识别 (ID) 系统
	Inspection Equipment - AOI	检测设备—AOI
	Inspection Equipment - X-ray	检测设备—X-Ray
	Manual Soldering Equipment	手工焊接设备
	Pick and Place Systems/Equipment	贴片系统 / 设备
	Programming	编程工具
	Reflow Soldering Equipment	回流焊接设备
	Repair/Rework Equipment	补焊 / 返修设备
	Stencil & Screen Printing Equipment	印刷系统 / 设备
	Process Control Systems	工艺控制系统
	Production Management Systems	生产管理系统
	Soldering Materials	焊接材料
	Test Systems/Equipment	测试系统 / 设备
	Wave Soldering Equipment	波峰焊设备

### C. PRODUCT INFORMATION (UP TO 250 WORDS in ENGLISH & SIMPLIFIED CHINESE) 产品介绍（请不超过 250 字）

Your submission must cover the following aspects of your product:  
您所提交介绍须包括以下内容:

- Innovation 创新性
- Cost effectiveness 性价比
- Speed/Throughput improvements 速度/产能改善情况
- Quality Contribution 质量贡献
- Ease of use 易用性
- Maintainability and reparability 可维护性与可维修性
- Technology advancement 技术先进性

Please submit the information on a separate sheet. 请使用单独附件提供相关信息。

### D. OTHER REQUIRED DOCUMENTS 其他必须文档

- A PDF or word file on technical specifications documenting a service program along with appropriate customer approval letter. 技术规格描述的 PDF 或 Word 文档，操作说明以及客户认可信
- High resolution product image (300 dpi and above)  
高清晰度产品照片（300dpi 或以上）
- Company name and standard product or service description to be used for judging and award purposes. 公司名称及标准产品或服务名称以备评选和颁奖使用

### E. TERMS & CONDITIONS 注意事项

- All payments made are not refundable. 所有的款项均不予退还。
- Winners will not be notified before the awards ceremony.  
获奖者将不会收到提前通知
- Entrants will receive a written invitation to the EM Asia Innovation Awards Presentation Ceremony. 所有参评者将获得 EM Asia 创新奖颁奖典礼的书面邀请。
- The *EM Asia Innovation Awards* is not affiliated to any advertising program in any manner. EM Asia 创新奖不带有任何广告性质。
- Winners are judged solely upon the merits of their product submissions.  
纯粹根据产品的性能评出获奖者。
- We reserve the right to not award a winner in a given category.  
我们保留在某一奖项无获奖者的权力。
- Materials submitted for competition will become the property of EM Asia and will not be returned. 提交材料归 EM Asia 所有，不予退还。
- Entries must be postmarked or emailed to us by 31 January 2008.  
参评产品报名表必须在 2008 年 1 月 31 日前发出。

**F. PAYMENT 付款方式**

I enclose a cheque/banker's draft for USD \_\_\_\_ made payable to **Reed Business Information Asia**. Cheque/Bank Draft Number:  
随信以支票/银行汇票支付 **Reed Business Information Asia** \_\_\_\_美元。支票/银行  
汇票号:

\_\_\_\_\_  
Name of Bank 银行名称: CITIBANK N.A.,  
Bank Address 银行地址: 3 Temasek Avenue, Centennial Tower #14-00  
Singapore 039190  
Account Number 帐号: 0-810497-335 (USD A/C)

Please debit USD \_\_\_\_ from my Visa/Mastercard/Amex card  
以 Visa /Mastercard/Amex 信用卡支付\_\_\_\_美元

**Card Number 卡号**

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**Card Expiry Date 卡有效期**

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**Card Holder's Name 持卡人姓名:** \_\_\_\_\_

**Signature 签名:** \_\_\_\_\_ **Date 日期:** \_\_\_\_\_

**G. SUBMISSION GUIDELINES 报名方式**

Please submit items A, B, C, D and E via email, CD or diskette to:  
请以邮件、CD 或磁盘形式提交报名表 A、B、C、D 及 E 部分至:

**Reed Business Information Asia**  
The Signature, 51 Changi Business Park Central 2, #07-01  
Singapore 486066  
Attention: June Tan, Publisher  
Email: [june.tan@rbi-asia.com](mailto:june.tan@rbi-asia.com)

If you have included any of the following, please tick the appropriate items:  
若含有其他附件, 请选择以下形式:

- CD-ROM 光盘
- Diskette 磁碟
- Print copies of product information and other required documents  
产品介绍和其他文档的印刷资料

## H. CERTIFICATION 证明

We certify that the information submitted in this entry form is true and its contents have been approved by authorized personnel for submission to the Electronics Manufacturing Asia Innovation Awards 2007.

We agree to the terms and conditions of the Awards and understand the information submitted here may be made known to the public. We also understand should the information given here be proven untrue, this entry may be disqualified, even if it has been selected as a winner.

我们保证报名表所提交的信息是真实的，所提交内容已被授权允许提交给 2008 EM Asia 创新奖评选。

我们赞同创新奖评选的条件和规则，并知道所提交的材料可能将向公众透漏。我们也充分理解以下行为，即：如果证明所提交的信息不真实，即使产品获奖也将被取消参评资格。

*Nomination is submitted by (please endorse with official company stamp):*  
提交人（公司印章）：

**Name 姓名:** \_\_\_\_\_

**Job title 职位:** \_\_\_\_\_

**Signature 签名:** \_\_\_\_\_ **Date 日期:** \_\_\_\_\_